



# THE DATASHEET OF BSP126,115



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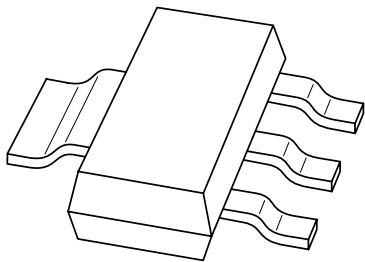
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Team Nexperia

# DATA SHEET



## **BSP126**

**N-channel enhancement mode  
vertical D-MOS transistor**

Product specification  
Supersedes data of 1997 Jun 23

2002 Feb 19

# N-channel enhancement mode vertical D-MOS transistor

## BSP126

### FEATURES

- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

### APPLICATIONS

- Line current interruptor in telephone sets
- Relay, high-speed and line transformer drivers.

### DESCRIPTION

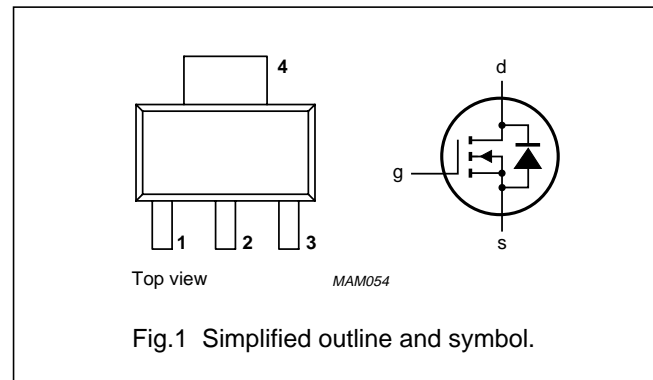
N-channel enhancement mode vertical D-MOS transistor in a miniature SOT223 package.

### MARKING

| TYPE NUMBER | MARKING CODE |
|-------------|--------------|
| BSP126      | BSP126       |

### PINNING - SOT223

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | gate        |
| 2   | drain       |
| 3   | source      |
| 4   | drain       |



### QUICK REFERENCE DATA

| SYMBOL     | PARAMETER                        | CONDITIONS                                  | TYP. | MAX. | UNIT     |
|------------|----------------------------------|---|------|------|----------|
| $V_{DS}$   | drain-source voltage (DC)        |   | –    | 250  | V        |
| $I_D$      | drain current (DC)               |   | –    | 375  | mA       |
| $P_{tot}$  | total power dissipation          | $T_{amb} \leq 25\text{ °C}$                 | –    | 1.5  | W        |
| $R_{DSon}$ | drain-source on-state resistance | $I_D = 300\text{ mA}; V_{GS} = 10\text{ V}$ | 2.8  | 5    | $\Omega$ |
| $V_{GSth}$ | gate-source threshold voltage    | $I_D = 1\text{ mA}; V_{DS} = V_{GS}$        | –    | 2    | V        |

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL    | PARAMETER                 | CONDITIONS                                 | MIN. | MAX.     | UNIT               |
|-----------|---------------------------|--|------|----------|--------------------|
| $V_{DS}$  | drain-source voltage (DC) |  | –    | 250      | V                  |
| $V_{GSO}$ | gate-source voltage (DC)  | open drain                                 | –    | $\pm 20$ | V                  |
| $I_D$     | drain current (DC)        |  | –    | 375      | mA                 |
| $I_{DM}$  | peak drain current        |  | –    | 1.3      | A                  |
| $P_{tot}$ | total power dissipation   | $T_{amb} \leq 25\text{ °C}; \text{note 1}$ | –    | 1.5      | W                  |
| $T_{stg}$ | storage temperature       |  | –55  | +150     | $^{\circ}\text{C}$ |
| $T_j$     | junction temperature      |  | –    | 150      | $^{\circ}\text{C}$ |

### Note

1. Device mounted on a  $40 \times 40 \times 1.5\text{ mm}$  epoxy printed-circuit board; mounting pad for the drain tab minimum  $6\text{ cm}^2$ .

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### THERMAL CHARACTERISTICS

| SYMBOL        | PARAMETER   | VALUE | UNIT |
|---------------|---|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient; note 1 | 83.3  | K/W  |

#### Note

1. Device mounted on a 40 × 40 × 1.5 mm epoxy printed-circuit board; mounting pad for the drain tab minimum 6 cm<sup>2</sup>.

### CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise specified.

| SYMBOL                                    | PARAMETER                        | CONDITIONS  | MIN. | TYP. | MAX. | UNIT          |
|---|----------------------------------|---|------|------|------|---------------|
| $V_{(BR)DSS}$                             | drain-source breakdown voltage   | $I_D = 10\ \mu\text{A}; V_{GS} = 0$   | 250  | –    | –    | V             |
| $I_{GSS}$                                 | gate-source leakage current      | $V_{GS} = \pm 20\ \text{V}; V_{DS} = 0$   | –    | –    | ±100 | nA            |
| $V_{GSth}$                                | gate-source threshold voltage    | $I_D = 1\ \text{mA}; V_{DS} = V_{GS}$   | 0.8  | –    | 2    | V             |
| $R_{DSon}$                                | drain-source on-state resistance | $I_D = 20\ \text{mA}; V_{GS} = 2.4\ \text{V}$   | –    | –    | 7.5  | $\Omega$      |
|   |                                  | $I_D = 300\ \text{mA}; V_{GS} = 10\ \text{V}$   | –    | 2.8  | 5    | $\Omega$      |
| $I_{DSS}$                                 | drain-source leakage current     | $V_{DS} = 200\ \text{V}; V_{GS} = 0$  | –    | –    | 1    | $\mu\text{A}$ |
| $ Y_{fs} $                                | transfer admittance              | $I_D = 300\ \text{mA}; V_{DS} = 25\ \text{V}$   | 200  | 600  | –    | mS            |
| $C_{iss}$                                 | input capacitance                | $V_{DS} = 25\ \text{V}; V_{GS} = 0; f = 1\ \text{MHz}$                                  | –    | 100  | 120  | pF            |
| $C_{oss}$                                 | output capacitance               | $V_{DS} = 25\ \text{V}; V_{GS} = 0; f = 1\ \text{MHz}$                                  | –    | 21   | 30   | pF            |
| $C_{rss}$                                 | feedback capacitance             | $V_{DS} = 25\ \text{V}; V_{GS} = 0; f = 1\ \text{MHz}$                                  | –    | 10   | 15   | pF            |
| <b>Switching times</b> (see Figs 2 and 3) |                                  |   |      |      |      |               |
| $t_{on}$                                  | turn-on time                     | $I_D = 250\ \text{mA}; V_{DD} = 50\ \text{V};$<br>$V_{GS} = 0\ \text{to}\ 10\ \text{V}$ | –    | 6    | 10   | ns            |
| $t_{off}$                                 | turn-off time                    | $I_D = 250\ \text{mA}; V_{DD} = 50\ \text{V};$<br>$V_{GS} = 10\ \text{to}\ 0\ \text{V}$ | –    | 47   | 60   | ns            |

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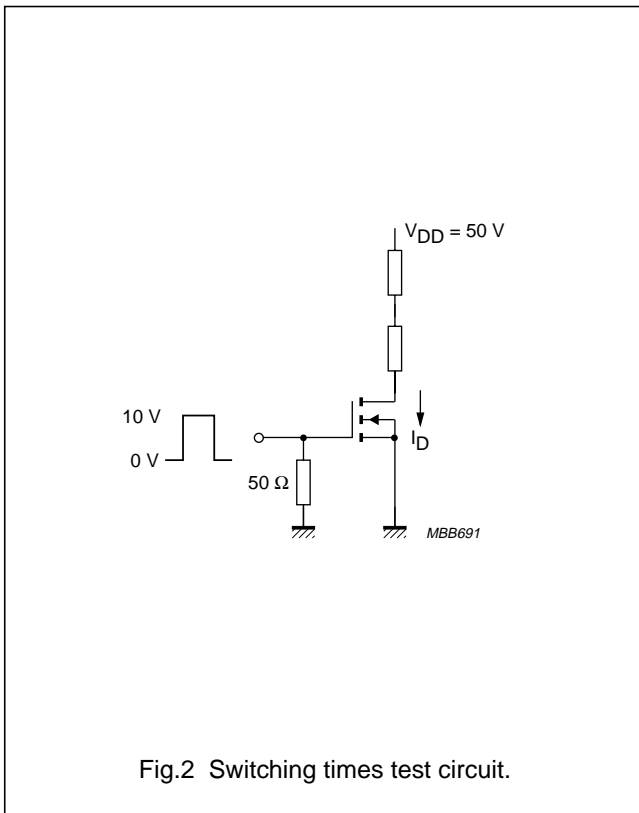


Fig.2 Switching times test circuit.

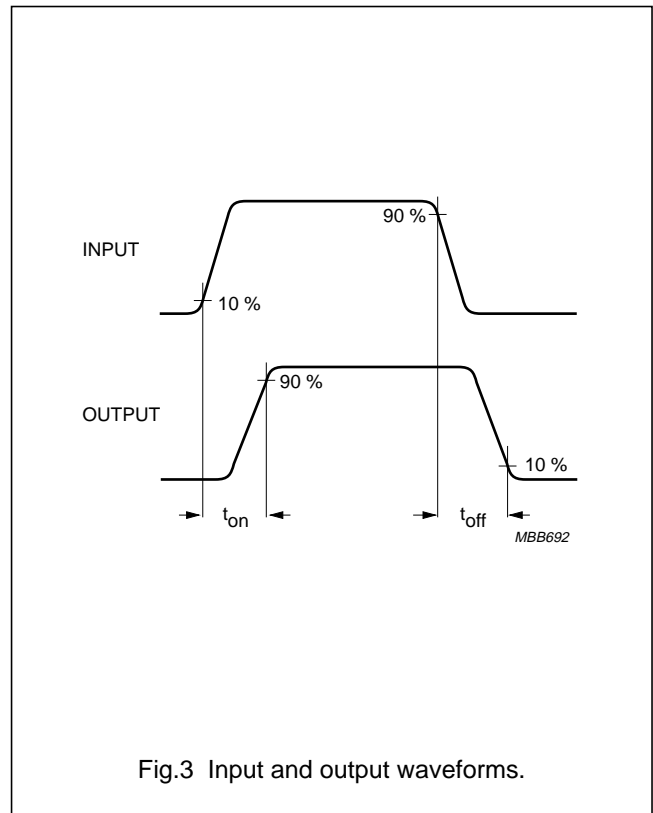


Fig.3 Input and output waveforms.

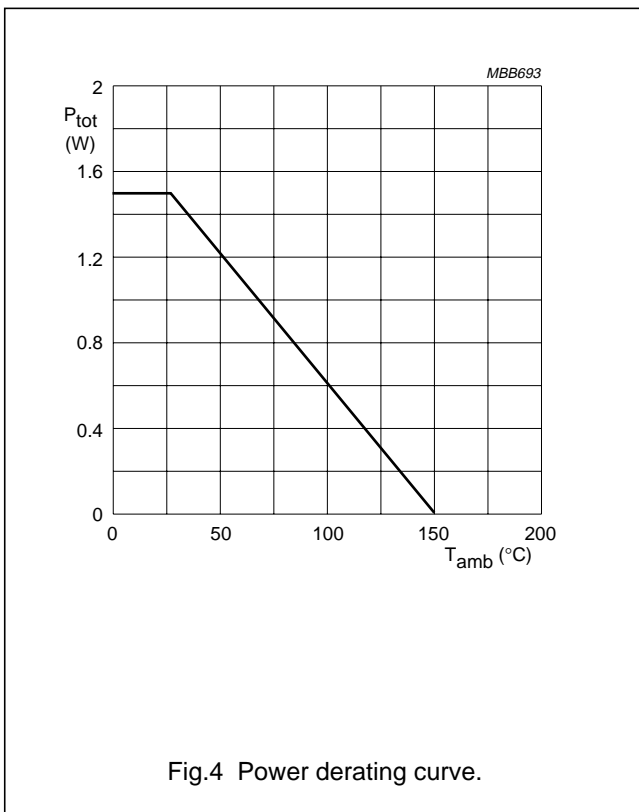


Fig.4 Power derating curve.

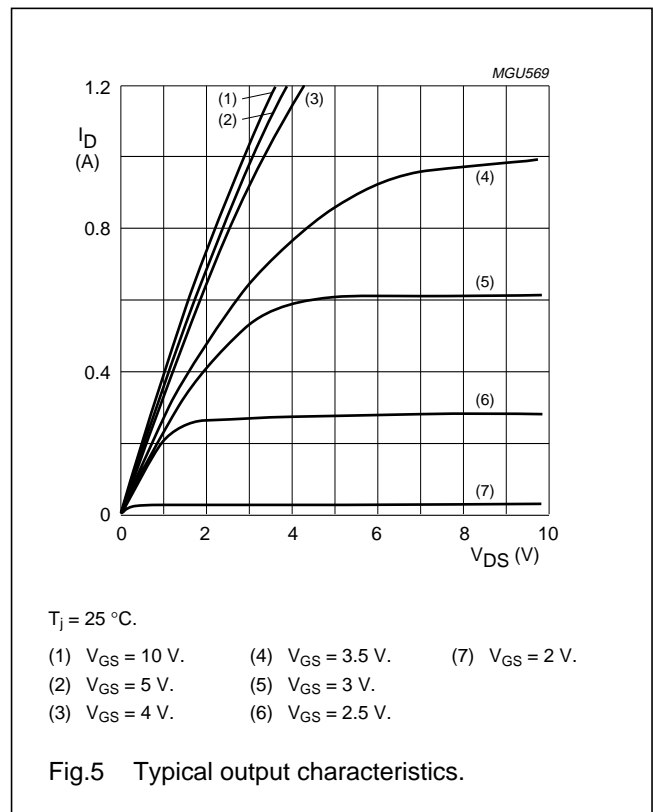
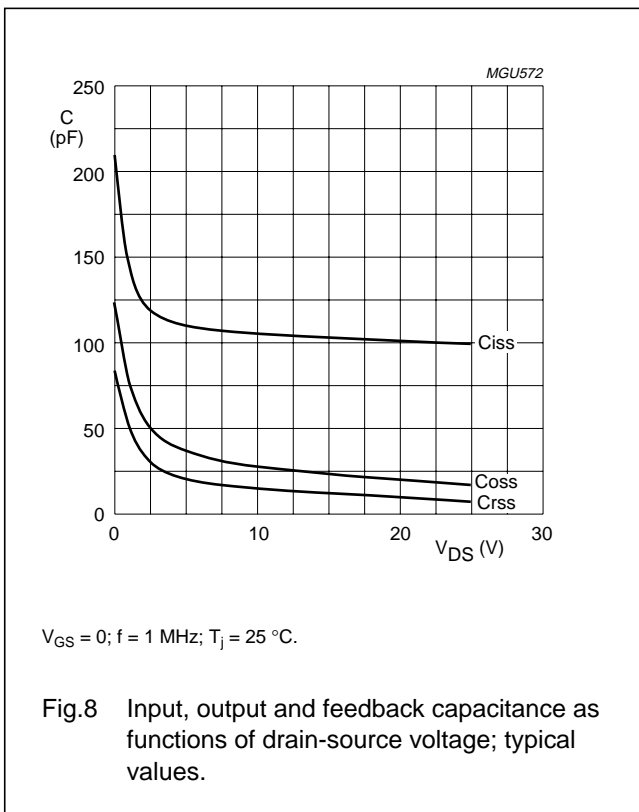
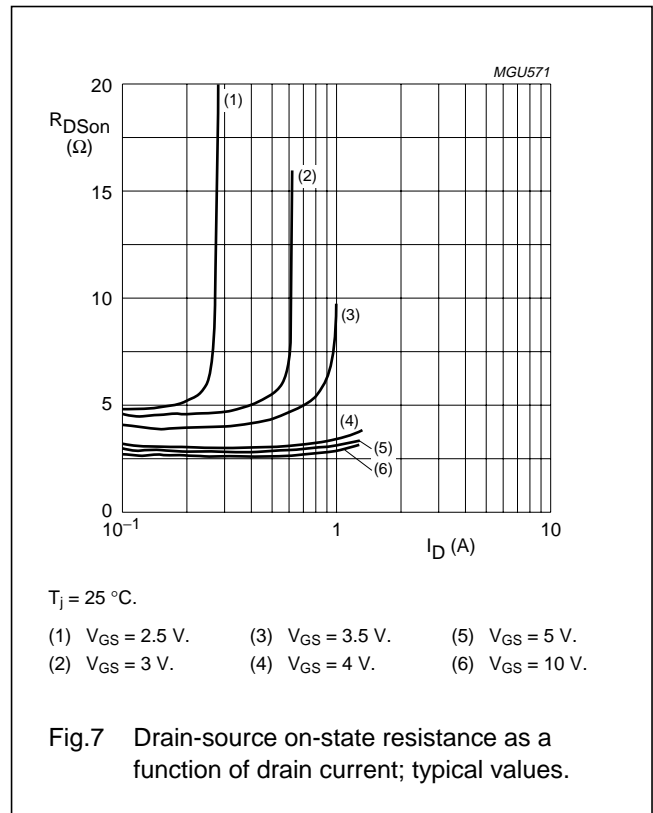
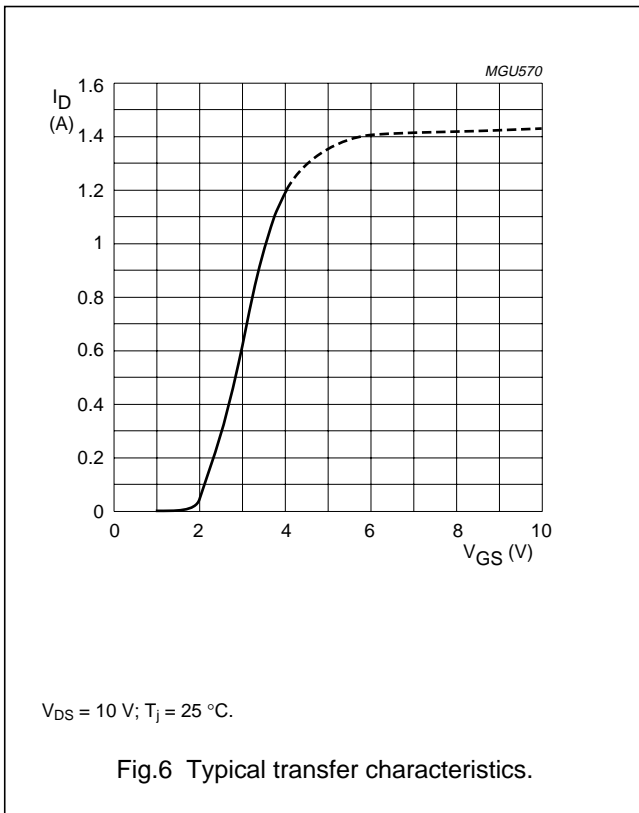


Fig.5 Typical output characteristics.

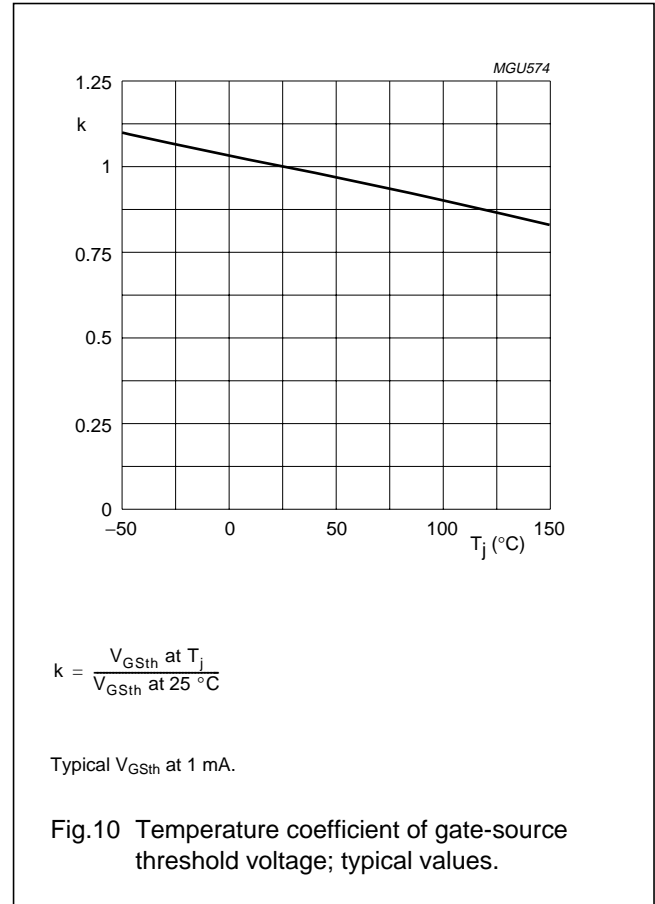
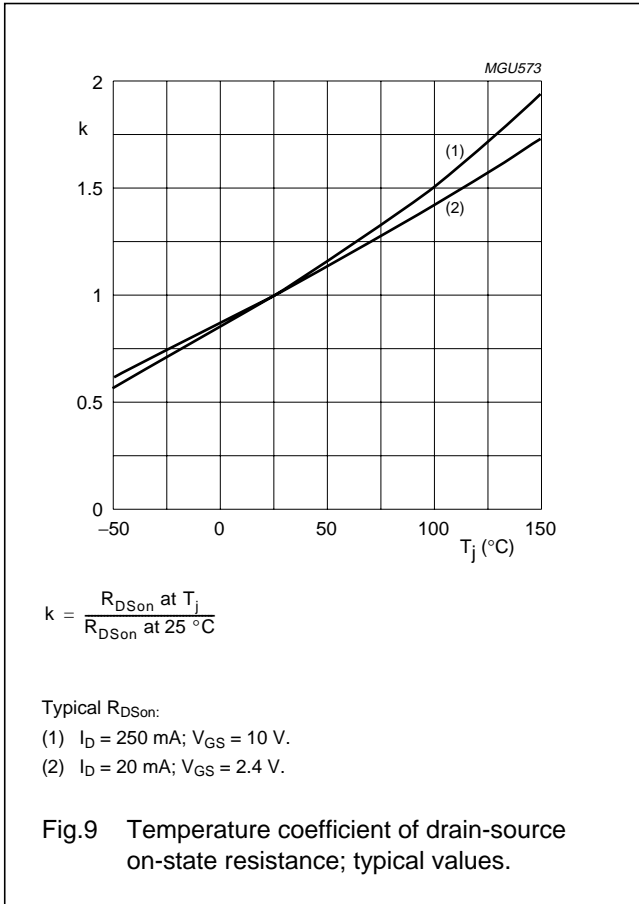
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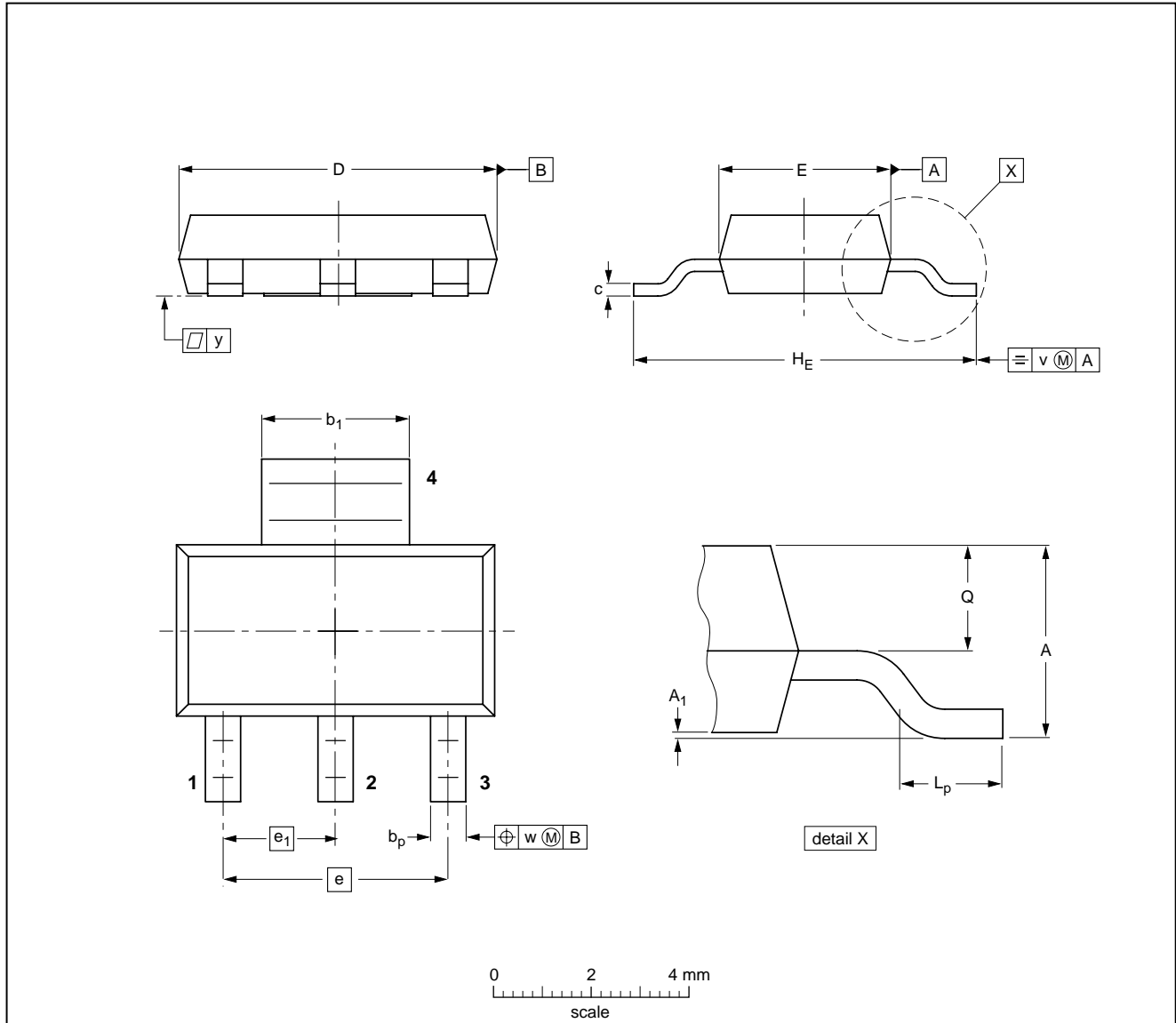
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



DIMENSIONS (mm are the original dimensions)

| UNIT | A          | A <sub>1</sub> | b <sub>p</sub> | b <sub>1</sub> | c            | D          | E          | e   | e <sub>1</sub> | H <sub>E</sub> | L <sub>p</sub> | Q            | v   | w   | y   |
|------|------------|----------------|----------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|--------------|-----|-----|-----|
| mm   | 1.8<br>1.5 | 0.10<br>0.01   | 0.80<br>0.60   | 3.1<br>2.9     | 0.32<br>0.22 | 6.7<br>6.3 | 3.7<br>3.3 | 4.6 | 2.3            | 7.3<br>6.7     | 1.1<br>0.7     | 0.95<br>0.85 | 0.2 | 0.1 | 0.1 |

| OUTLINE VERSION | REFERENCES |       |       | EUROPEAN PROJECTION | ISSUE DATE           |
|-----------------|------------|-------|-------|---------------------|----------------------|
|                 | IEC        | JEDEC | EIAJ  |                     |                      |
| SOT223          |            |       | SC-73 |                     | 97-02-28<br>99-09-13 |

# N-channel enhancement mode vertical D-MOS transistor

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| DATA SHEET STATUS <sup>(1)</sup> | PRODUCT STATUS <sup>(2)</sup> | DEFINITIONS  |
|----------------------------------|-------------------------------|--|
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**NOTES**

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**NOTES**

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Printed in The Netherlands

613510/03/pp12

Date of release: 2002 Feb 19

Document order number: 9397 750 09311

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